PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
XIANMING ZHANG	09/18/2017
LING TANG	09/18/2017
LEIBIN YUAN	09/18/2017
FENG DOU	09/18/2017
FENG CHEN	09/18/2017

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (SHANGHAI) CORPORATION	
Street Address:	18 ZHANGJIANG ROAD	
Internal Address:	PUDONG NEW AREA	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201203	
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL (BEIJING) CORPORATION	
Street Address:	18 WENCHANG ROAD	
Internal Address:	BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA, DAXING DISTRICT	
City:	BEIJING	
State/Country:	CHINA	
Postal Code:	100176	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15820561

CORRESPONDENCE DATA

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PATENT

504654863 REEL: 044200 FRAME: 0059

Correspondent Name: GANG CHEN

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Address Line 2: POST OFFICE BOX 10395
Address Line 4: CHICAGO, ILLINOIS 60610

ATTORNEY DOCKET NUMBER: 15741-16 2016-00450-SH-US

NAME OF SUBMITTER: GANG CHEN, REG. NO. 68,754

SIGNATURE: /Gang Chen/
DATE SIGNED: 11/22/2017

Total Attachments: 2

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> PATENT REEL: 044200 FRAME: 0060

ASSIGNMENT

WHEREAS, Xianming ZHANG, Ling TANG, Leibin YUAN, Feng DOU, and Feng CHEN, the "Assignor", has made the invention described in the United States patent application entitled SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREFOR, executed by Assignor on the same date as, or on a date prior to, this Assignment;

WHEREAS, Semiconductor Manufacturing International (Shanghai) Corporation, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Zhangjiang Road, Pudong New Area, Shanghai 201203, China and Semiconductor Manufacturing International (Beijing) Corporation, a corporation organized and existing under the laws of the Country of China, having a place of business at 18 Wenchang Road, Beijing Economic-Technological Development Area, Diaxing District, Beijing 100176, China, hereinafter the "Assignee", desires to acquire the entire right, title and interest in the invention and the patent application identified above, and all patents which may be obtained for the invention, as set forth below;

NOW, THEREFORE, in consideration of valuable and legally sufficient consideration, the receipt of which by the Assignor from the Assignee is acknowledged, the Assignor has sold, assigned and transferred, and by these presents sells, assigns and transfers to the Assignee, the entire right, title and interest for the United States in the invention and the patent application identified above, and any patents that may issue for the invention in the United States; with the entire right, title and interest in the invention and all patent applications and patents issuing therefrom in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; with the entire right, title and interest in all continuations, divisions, renewals and extensions of any of the patent applications and patents defined above; with the right to recover all damages, including, but not limited to, a reasonable royalty, by reason of past, present, or future infringement or any other violation of patent or patent application rights; to have hold for

PATENT REEL: 044200 FRAME: 0061 the sole and exclusive use and benefit of the Assignee, its successors and assigns, to the full end of the term or terms for all such patents.

The Assignor covenants and agrees, for both the Assignor and the Assignor's legal representatives, that the Assignor will assist the Assignee in the prosecution of the patent application identified above; in the making and prosecution of any other patent applications that the Assignee may elect to make covering the invention identified above; in vesting in the Assignee like exclusive title in all such other patent applications and patents; and that the Assignor will execute and deliver to the Assignee any and all additional papers which may be requested by the Assignee to carry out the terms of this Assignment.

The Commissioner of Patents and Trademarks is authorized and requested to issue patents to the Assignee under the terms of this Assignment.

IN TESTIMONY WHEREOF, the Assignor has executed this agreement.

DATED:	Seff. 18, 2017	Xianning Sharg
DATED	Sep 18. 2017	Xianming ZHANG Lary Targ
DATED		Ling TANG
DATED	Sep. 18, 2017	Lei bin YUAN Leibin YUAN
DATED	Spe 18, 20,	Feng Don Feng DOU
DATED	Sep. 19, 201)	teng CHBN
		Feng-CHEN